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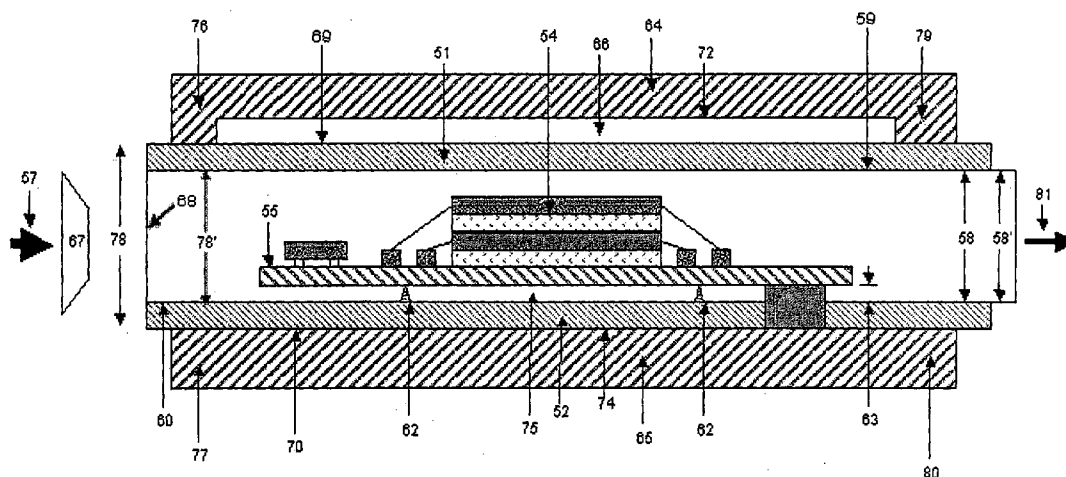
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(54) Title: METHOD OF MAKING A MEMORY CARD BY INJECTION MOLDING



(57) Abstract: Memory Card (10) containing Integrated Circuits and other electronic components is made by means of injection molding. External surfaces of e.g. polycarbonate, synthetic paper, PVC or the like are used to house the Memory Card (10) or similar device prior to the injection molding step. After a thermosetting material is injection molded the Memory Card (10) is removed from the two (2) mold halves and is trimmed.

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